



#### **DATA BUS TRANSIENT SUPPRESSOR**

#### **Features**

- ESD Protection >30kV (Human Body Model) (Note 1)
- Ultra-Small Surface Mount Package
- Protects 2 Data Lines
- Low Leakage <25nA</li>
- Low Capacitance 3pF Typ.
- Protects USB 2.0 and USB 1.1
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 2, 3 and 4)

#### **Mechanical Data**

- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Orientation: See Diagram Below
- Weight: 0.006 grams (approximate)

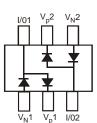
#### EC Compatibility (Note 1)

- 61000-4-2 (ESD) Air-30kV Contact-30kV
- 61000-4-4 (EFT) 40A, 5/50 ns
- 61000-4-5 (Surge) 8x20μs, 20 Amperes

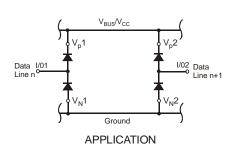




Top View



Internal Schematic



Top View

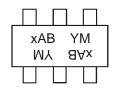
### **Ordering Information** (Note 5)

Part Number	Case	Packaging
SDA004-7	SOT-363	3000/Tape & Reel

Notes:

- 1. Tested with  $V_P$  connected to  $V_N$  to simulate appropriate  $V_{BUS}/V_{CC}$  decoupling to ground.
- 2. No purposefully added lead. Halogen and Antimony Free.
- 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.
- 5. For packaging details, go to our website at http://www.diodes.com.

### **Marking Information**



KAB or JAB = Product Type Marking Code YM = Date Code Marking Y = Year ex: R = 2004 M = Month ex: 9 = September

Date Code Key

Year	2004	2005	2006	2007	2008	2009	2010	2111	2012	2013	2014	2015
Code	R	S	Т	U	V	W	Х	Y	Z	Α	В	С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



## **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	80	V
Forward Continuous Current (Note 6)	I <sub>FM</sub>	500	mA
Repetitive Peak Forward Current @ T <sub>p</sub> = 5μs, f = 50kHz (Note 6)	I <sub>FRM</sub>	1000	mA
Non-Repetitive Peak Forward Surge Current @ t = @ t =	, I LCM	20 1.0	Α
Clamping Voltage @ I <sub>pp</sub> = 20A (Note 7) 8x20µs Waveform	Vc	16	V

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	$P_D$	200	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

## Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition						
Reverse Breakdown Voltage (Note 8)	$V_{(BR)R}$	80		_	V	$I_R = 100 \mu A$						
		0.62		0.72		I <sub>F</sub> = 5.0mA						
Forward Voltage	VF	_		0.93	V	$I_F = 20 \text{mA}$						
Tolward voltage		_	_	1.0	V	I <sub>F</sub> = 100mA						
		—		1.25		I <sub>F</sub> = 150mA						
				100	nA	V <sub>R</sub> = 70V						
Reverse Current (Note 8)	I <sub>R</sub>	I <sub>R</sub>	$I_R$	$I_R$	$I_R$	1_	I_			50	μΑ	$V_R = 75V, T_J = 150^{\circ}C$
Reverse Current (Note 6)						_		30	μΑ	V <sub>R</sub> = 25V, T <sub>J</sub> = 150°C		
					25	nA	$V_R = 20V$					
Capacitance, Between I/O Lines (I/O1 & I/O2)	$C_{LL}$		2.5	4.0	pF	$V_R = 0V, f = 1.0MHz$						
Capacitance Between I/O Line and Ground	$C_{LG}$		3.3	5.3	pF	$V_R = 0V$ , $f = 1.0MHz$						
Reverse Recovery Time	t <sub>rr</sub>	_	_	4.0	ns	$V_R = 6V$ , $I_F = 5mA$						

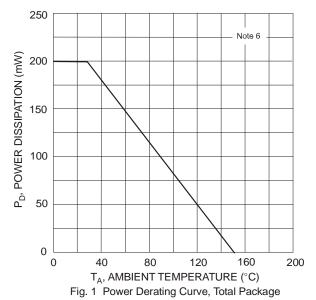
Notes:

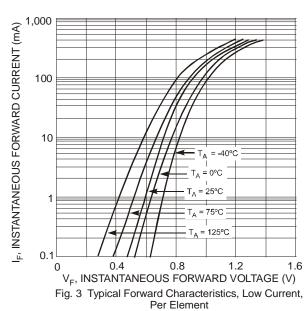
<sup>6.</sup> Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com.

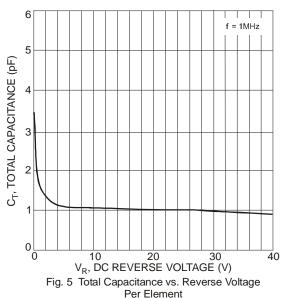
7. Referenced to V<sub>P</sub> or V<sub>N</sub>.

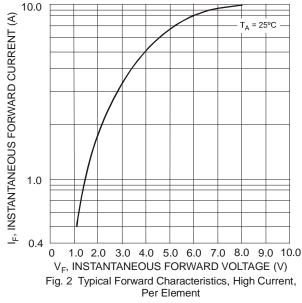
8. Short duration pulse test used to minimize self-heating effect.

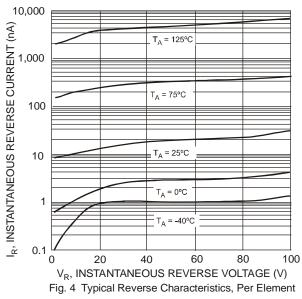












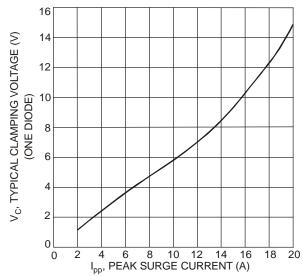
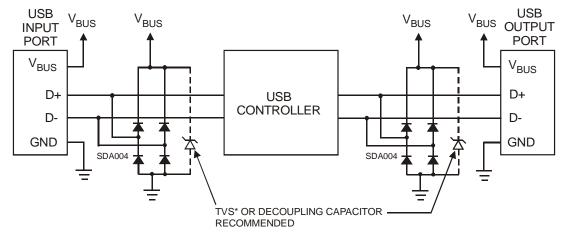


Fig. 6 6100-4-5 8x20µs Surge Response, Per Element

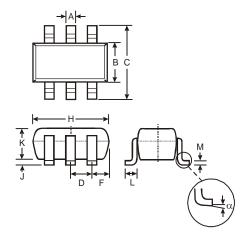




\* MMBZ6V8AL OR EQUIVALENT

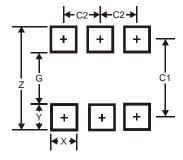
**ESD PROTECTION - USB APPLICATION** 

## **Package Outline Dimensions**



SOT-363					
Dim	Min	Max			
Α	0.10	0.30			
В	1.15	1.35			
С	2.00	2.20			
D	0.65 Typ				
F	0.40	0.45			
Н	1.80	2.20			
J	0	0.10			
K	0.90	1.00			
L	0.25	0.40			
М	0.10	0.22			
α	0°	8°			
All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65



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